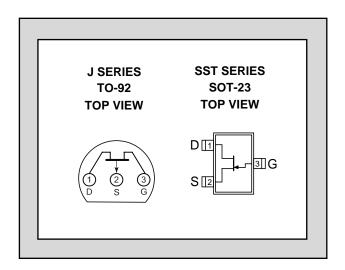


Twenty-Five Years Of Quality Through Innovation

J/SST111 SERIES

SINGLE N-CHANNEL JFET SWITCH

FEATURES						
DIRECT REPLACEMENT FOR SILICONIX J/SST111 SERIES						
LOW GATE LEAKAGE CURRENT	5pA					
FAST SWITCHING 4ns						
ABSOLUTE MAXIMUM RATINGS ¹						
@ 25 °C (unless otherwise stated)						
Maximum Temperatures						
Storage Temperature -55 to 150°C						
Junction Operating Temperature	-55 to 150°C					
Maximum Power Dissipation						
Continuous Power Dissipation (J) ³	360mW					
Continuous Power Dissipation (SST) ³	350mW					
Maximum Currents						
Gate Current	50mA					
Maximum Voltages						
Gate to Drain	-35V					
Gate to Source	-35V					



STATIC ELECTRICAL CHARACTERISTICS @25 °C (unless otherwise stated)

SYM.	CHARACTERISTIC	TYP	J/SS	T111	J/SS	T112	J/SS	T113	LIMIT	CONDITIONS
STIVI.	CHARACTERISTIC	ITP	MIN	MAX	MIN	MAX	MIN	MAX	UNIT	CONDITIONS
BV _{GSS}	Gate to Source Breakdown Voltage		-35		-35		-35			$I_G = -1\mu A$, $V_{DS} = 0V$
V _{GS(off)}	Gate to Source Cutoff Voltage		-3	-10	-1	-5		-3	V	$V_{DS} = 5V, I_{D} = 1\mu A$
V _{GS(F)}	Gate to Source Forward Voltage	0.7								$I_G = 1mA$, $V_{DS} = 0V$
I _{DSS}	Drain to Source Saturation Current ²		20		5		2		mΑ	$V_{DS} = 15V$, $V_{GS} = 0V$
Igss	Gate Leakage Current	-0.005		-1		-1		-1	nΑ	$V_{GS} = -15V, V_{DS} = 0V$
lg	Gate Operating Current	-5							pΑ	$V_{DG} = 15V, I_D = 1.0 \text{mA}$
I _{D(off)}	Drain Cutoff Current	0.005		1		1		1	nA	$V_{DS} = 5V, V_{GS} = -10V$
r _{DS(on)}	Drain to Source On Resistance			30		50		100	Ω	$V_{GS} = 0V, V_{DS} = 0.1V$

DYNAMIC ELECTRICAL CHARACTERISTICS @25 °C (unless otherwise stated)

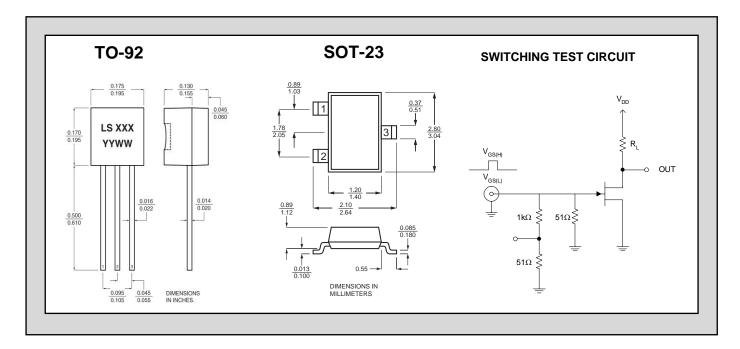
SYM.	CHARACTERISTIC	ТҮР	J/SST111		J/SST112		J/SST113		UNIT	CONDITIONS
			MIN	MAX	MIN	MAX	MIN	MAX	UNIT	CONDITIONS
g fs	Forward Transconductance	6							mS	$V_{DS} = 20V, I_{D} = 1mA$
gos	Output Conductance	25							μS	f = 1 kHz
r _{ds(on)}	Drain to Source On Resistance			30		50		100	Ω	$V_{GS} = 0V$, $I_D = 1mA$ f = 1kHz
Ciss	Input Capacitance	7		12		12		12		$V_{DS} = 0V$, $V_{GS} = -10V$ f = 1MHz
Crss	Reverse Transfer Capacitance	3		5		5		5	pF	
en	Equivalent Noise Voltage	3							nV/√Hz	$V_{DG} = 10V, I_{D} = 1mA$ f = 1 kHz

SWITCHING CHARACTERISTICS

SYM.	CHARACTERISTIC	TYP	UNIT	CONDITIONS	
t _{d(on)}	Turn On Time	2	ns		
tr	Tulli On Tille	2		$V_{DD} = 10V$ $V_{GS(H)} = 0V$	
t _{d(off)}	Turn Off Time	6			
t _f	Tulli Oli Time	15			

SWITCHING CIRCUIT CHARACTERISTICS

SYM.	J/SST111	J/SST112	J/SST113
V _{GS(L)}	-12V	-7V	-5V
R∟	800Ω	1600Ω	3200Ω
$I_{D(on)}$	12mA	6mA	3mA



NOTES

- 1. Absolute maximum ratings are limiting values above which serviceability may be impaired.
- 2. Pulse test: PW ≤ 300µs, Duty Cycle ≤ 3%
- 3. Derate 2.8mW/°C above 25°C

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